

Applic. No. 10/765,584
Amdt. dated August 22, 2005
Reply to Office action of May 20, 2005

Specification Amendments

Replace the title of the invention with the following:

-- ~~ELECTRONIC COMPONENT, METHOD FOR ENCAPSULATING THE~~
~~COMPONENT, AND METHOD FOR PRODUCING COMPONENTS ACCORDING TO~~
~~THE METHOD~~ METHOD FOR ENCAPSULATING A PLURALITY OF ELECTRONIC
COMPONENTS--